

STF7N60M2

Datasheet - production data

N-channel 600 V, 0.86 Ω typ., 5 A MDmesh II Plus™ low Q_g Power MOSFET in TO-220FP package

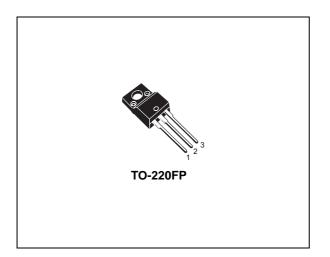
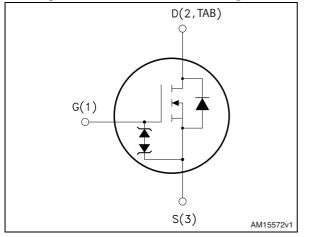


Figure 1. Internal schematic diagram



Features

Order code	V _{DS} @ T _{Jmax}	R _{DS(on)} max	I _D
STF7N60M2	650 V	0.95 Ω	5 A

- Extremely low gate charge
- Lower R_{DS(on)} x area vs previous generation
- Low gate input resistance
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This device is an N-channel Power MOSFET developed using a new generation of MDmeshTM technology: MDmesh II PlusTM low Q_g . This revolutionary Power MOSFET associates a vertical structure to the company's strip layout to yield one of the world's lowest on-resistance and gate charge. It is therefore suitable for the most demanding high efficiency converters.

Order code	Marking	Package	Packaging
STF7N60M2	7N60M2	TO-220FP	Tube

DocID024894 Rev 1

1/13

This is information on a product in full production.

Contents

1	Electrical ratings	3
2	Electrical characteristics	4
	2.1 Electrical characteristics (curves)	6
3	Test circuits	8
4	Package mechanical data	9
5	Revision history1	2



1 Electrical ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate-source voltage	± 25	V
Ι _D	Drain current (continuous) at T _C = 25 °C	5 ⁽¹⁾	А
Ι _D	Drain current (continuous) at T _C = 100 °C	3.5 ⁽¹⁾	А
I _{DM} ⁽¹⁾	Drain current (pulsed)	20 ⁽¹⁾	А
P _{TOT}	Total dissipation at $T_C = 25 \ ^{\circ}C$	20	W
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1 s; $T_C=25$ °C)	2500	V
dv/dt ⁽²⁾	Peak diode recovery voltage slope	15	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50 V/n	
T _{stg}	Storage temperature	55 to 150	℃
Тj	Max. operating junction temperature	- 55 to 150	

Table 2. Absolute maximum ratings	solute maximum ratin	qs
-----------------------------------	----------------------	----

1. Pulse width limited by safe operating area.

2. $I_{SD} \leq$ 5 A, di/dt \leq 400 A/µs; V_{DS peak} < V_{(BR)DSS}, V_{DD}=400 V

3. $V_{DS} \leq 480 \text{ V}$

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	6.25	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	62.5	°C/W

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T_{jmax})	1.5	A
E _{AS}	Single pulse avalanche energy (starting T_j =25°C, I_D = I_{AR} ; V_{DD} =50)	99	mJ



2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0	600			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = 600 V V _{DS} = 600 V, T _C =125 °C			1 100	μA μA
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 25 V			±10	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 2.5 A		0.86	0.95	Ω

Table	5.	On	/off	states
-------	----	----	------	--------

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	271	-	pF
C _{oss}	Output capacitance	V _{DS} = 100 V, f = 1 MHz,	-	15.7	-	pF
C _{rss}	Reverse transfer capacitance	V _{GS} = 0	-	0.68	-	pF
C _{oss eq.} ⁽¹⁾	Equivalent output capacitance	$V_{DS} = 0$ to 480 V, $V_{GS} = 0$	-	75.5	-	pF
R _G	Intrinsic gate resistance	f = 1 MHz open drain	-	7.2	-	Ω
Qg	Total gate charge	V _{DD} = 480 V, I _D = 5 A,	-	8.8	-	nC
Q _{gs}	Gate-source charge	V _{GS} = 10 V	-	1.8	-	nC
Q _{gd}	Gate-drain charge	(see Figure 15)	-	4.3	-	nC

1. $C_{oss eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 7	7. Switcl	hing times
---------	-----------	------------

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, I_D = 2.5 \text{ A},$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$ (see <i>Figure 14</i> and <i>19</i>)	-	7.6	-	ns
t _r	Rise time		-	7.2	-	ns
t _{d(off)}	Turn-off delay time		-	19.3	-	ns
t _f	Fall time		-	15.9	-	ns



Symbol	Parameter	Test conditions	Min.	Turn	Max.	Unit
Symbol	Farailleter	lest conditions	wiin.	Тур.	wax.	Unit
I _{SD} I _{SDM} ⁽¹⁾	Source-drain current Source-drain current (pulsed)		-		5 20	A A
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 5 \text{ A}, V_{GS} = 0$	-		1.6	V
t _{rr}	Reverse recovery time		-	275		ns
Q _{rr}	Reverse recovery charge	I _{SD} = 5 A, di/dt = 100 A/μs V _{DD} = 60 V (see <i>Figure 19</i>)	-	1.55		nC
I _{RRM}	Reverse recovery current		-	11		А
t _{rr}	Reverse recovery time	I _{SD} = 5 A, di/dt = 100 A/µs	-	376		ns
Q _{rr}	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$	-	2.1		nC
I _{RRM}	Reverse recovery current	(see Figure 19)	-	11		А

Table 8. Source drain diode

1. Pulse width limited by safe operating area.

2. Pulsed: pulse duration = $300 \ \mu$ s, duty cycle 1.5%



2.1 Electrical characteristics (curves)

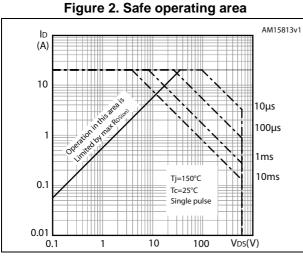
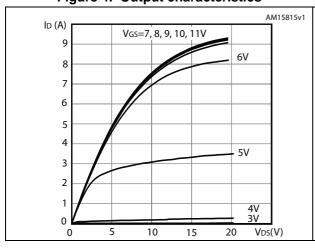
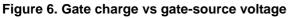
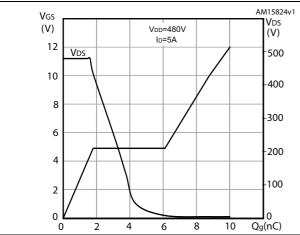


Figure 4. Output characteristics







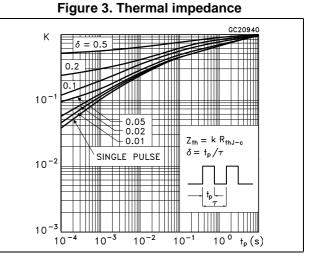
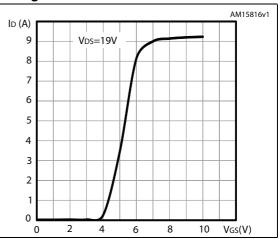
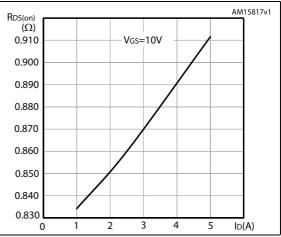


Figure 5. Transfer characteristics







DocID024894 Rev 1



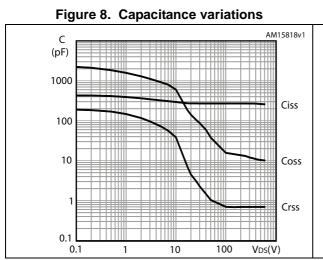


Figure 10. Normalized gate threshold voltage vs. temperature

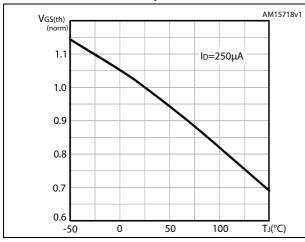


Figure 12. Drain-source diode forward characteristics

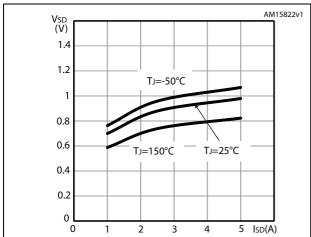


Figure 9. Output capacitance stored energy

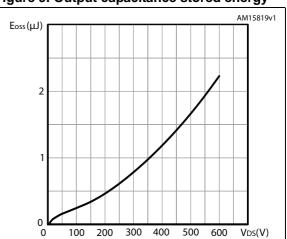


Figure 11. Normalized on-resistance vs. temperature

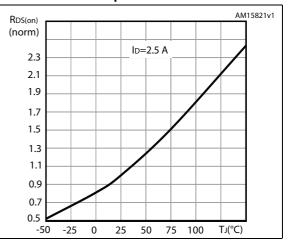
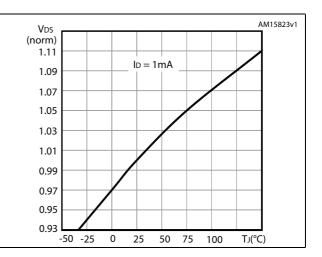


Figure 13. Normalized V_{DS} vs. temperature





3 Test circuits

Figure 14. Switching times test circuit for resistive load

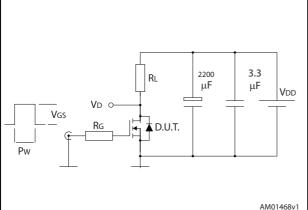


Figure 16. Test circuit for inductive load switching and diode recovery times

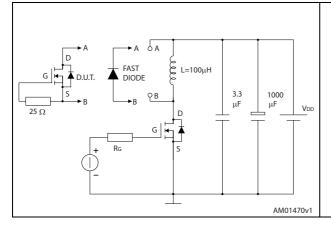


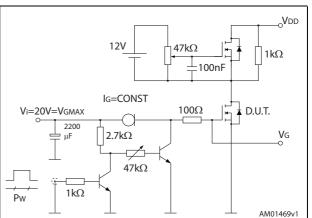
Figure 18. Unclamped inductive waveform

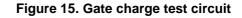
VD

ldм

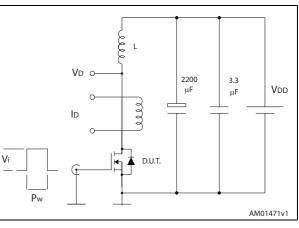
ID

V(BR)DSS









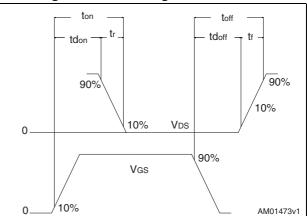


Figure 19. Switching time waveform



Vdd

AM01472v1



Vdd

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

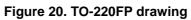


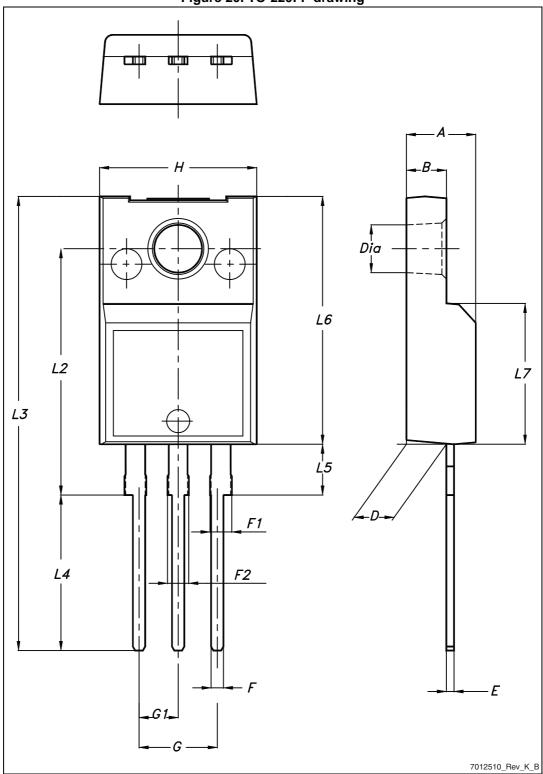
Package mechanical data

Table 9. TO-220FP mechanical data					
Dim.	mm				
	Min.	Тур.	Max.		
А	4.4		4.6		
В	2.5		2.7		
D	2.5		2.75		
Е	0.45		0.7		
F	0.75		1		
F1	1.15		1.70		
F2	1.15		1.70		
G	4.95		5.2		
G1	2.4		2.7		
Н	10		10.4		
L2		16			
L3	28.6		30.6		
L4	9.8		10.6		
L5	2.9		3.6		
L6	15.9		16.4		
L7	9		9.3		
Dia	3		3.2		

Table 9. TO-220FP mechanical data









DocID024894 Rev 1

5 **Revision history**

Table 10. Document	revision history
--------------------	------------------

Table 10. Document revision history				
Date	Date Revision Changes			
26-Jun-2013	1	First release.		



Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

ST PRODUCTS ARE NOT AUTHORIZED FOR USE IN WEAPONS. NOR ARE ST PRODUCTS DESIGNED OR AUTHORIZED FOR USE IN: (A) SAFETY CRITICAL APPLICATIONS SUCH AS LIFE SUPPORTING, ACTIVE IMPLANTED DEVICES OR SYSTEMS WITH PRODUCT FUNCTIONAL SAFETY REQUIREMENTS; (B) AERONAUTIC APPLICATIONS; (C) AUTOMOTIVE APPLICATIONS OR ENVIRONMENTS, AND/OR (D) AEROSPACE APPLICATIONS OR ENVIRONMENTS. WHERE ST PRODUCTS ARE NOT DESIGNED FOR SUCH USE, THE PURCHASER SHALL USE PRODUCTS AT PURCHASER'S SOLE RISK, EVEN IF ST HAS BEEN INFORMED IN WRITING OF SUCH USAGE, UNLESS A PRODUCT IS EXPRESSLY DESIGNATED BY ST AS BEING INTENDED FOR "AUTOMOTIVE, AUTOMOTIVE SAFETY OR MEDICAL" INDUSTRY DOMAINS ACCORDING TO ST PRODUCT DESIGN SPECIFICATIONS. PRODUCTS FORMALLY ESCC, QML OR JAN QUALIFIED ARE DEEMED SUITABLE FOR USE IN AEROSPACE BY THE CORRESPONDING GOVERNMENTAL AGENCY.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries. Information in this document supersedes and replaces all information previously supplied. The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2013 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



DocID024894 Rev 1

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

STMicroelectronics: STF7N60M2